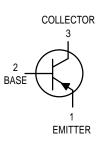
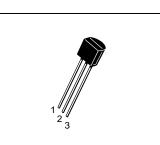
Switching Transistor

PNP Silicon





MPS3640

MAXIMUM RATINGS

Rating	Symbol	Value	Unit	
Collector-Emitter Voltage	VCEO	-12	Vdc	
Collector-Base Voltage	VCBO	-12	Vdc	
Emitter-Base Voltage	VEBO	-4.0	Vdc	
Collector Current — Continuous	IC	-80	mAdc	
Total Device Dissipation @ T _A = 25°C Derate above 25°C	PD	625 5.0	mW mW/°C	
Total Device Dissipation @ T _C = 25°C Derate above 25°C	PD	1.5 12	Watts mW/°C	
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-55 to +150	°C	

CASE 29-04, STYLE 1 TO-92 (TO-226AA)

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	R _{0JA}	200	°C/W
Thermal Resistance, Junction to Case	R _{θJC}	83.3	°C/W

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic Symbol Min Max Unit **OFF CHARACTERISTICS** Collector-Emitter Breakdown Voltage -12 Vdc V(BR)CES $(I_C = -100 \ \mu Adc, \ V_{BE} = 0)$ Collector-Emitter Sustaining Voltage(1) Vdc VCEO(sus) -12 ____ $(I_{C} = -10 \text{ mAdc}, I_{B} = 0)$ Collector-Base Breakdown Voltage V(BR)CBO -12 Vdc $(I_{C} = -100 \ \mu Adc, I_{E} = 0)$ Emitter-Base Breakdown Voltage V(BR)EBO -4.0 Vdc ____ $(I_E = -100 \ \mu Adc, I_C = 0)$ **Collector Cutoff Current** ICES μAdc $(\mathsf{V}_{\mathsf{CE}}=-6.0~\mathsf{Vdc},~\mathsf{V}_{\mathsf{BE}}=0)$ -0.01 $(V_{CE} = -6.0 \text{ Vdc}, V_{BE} = 0, T_A = 65^{\circ}\text{C})$ ____ -1.0 Base Current -10 IB nAdc $(V_{CE} = -6.0 \text{ Vdc}, V_{EB} = 0)$

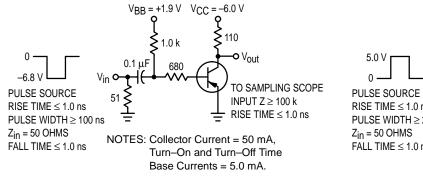
1. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2.0%.



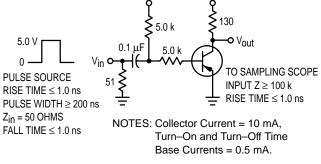
ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted) (Continued)

	Characteristic	Symbol	Min	Max	Unit
ON CHARACTER	RISTICS(1)			•	
	V _{CE} = -0.3 Vdc) V _{CE} = -1.0 Vdc)	hFE	30 20	120 —	—
$(I_{C} = -50 \text{ mAdc},$	Saturation Voltage $I_B = -1.0 \text{ mAdc}$ $I_B = -5.0 \text{ mAdc}$ $I_B = -1.0 \text{ mAdc}, T_A = 65^{\circ}\text{C}$	V _{CE(sat)}		-0.2 -0.6 -0.25	Vdc
$(I_{C} = -10 \text{ mAdc},$	$ I_{B} = -0.5 \text{ mAdc}) I_{B} = -1.0 \text{ mAdc}) I_{B} = -5.0 \text{ mAdc}) $	VBE(sat)	-0.75 -0.75 	-0.95 -1.0 -1.5	Vdc
SMALL-SIGNAL	CHARACTERISTICS				
Current-Gain — E (I _C = -10 mAdc,	andwidth Product V _{CE} = –5.0 Vdc, f = 100 MHz)	fΤ	500	-	MHz
Output Capacitanc (V _{CB} = -5.0 Vdc	e c, I _E = 0, f = 1.0 MHz)	C _{obo}	_	3.5	pF
Input Capacitance (V _{EB} = -0.5 Vdd	;, I _C = 0, f = 1.0 MHz)	C _{ibo}	_	3.5	pF
SWITCHING CH	ARACTERISTICS	•		•	
Delay Time	$(V_{CC} = -6.0 \text{ Vdc}, I_{C} = -50 \text{ mAdc}, V_{BE(off)} = -1.9 \text{ Vdc},$	td	—	10	ns
Rise Time	I _{B1} = -5.0 mAdc)	tr	_	30	ns
Storage Time	$(V_{CC} = -6.0 \text{ Vdc}, I_C = -50 \text{ mAdc}, I_{B1} = I_{B2} = -5.0 \text{ mAdc})$	t _S	_	20	ns
Fall Time		tf	_	12	ns
	c, $I_C = -50 \text{ mAdc}$, $I_{B1} = -5.0 \text{ mAdc}$) c, $I_C = -10 \text{ mAdc}$, $I_{B1} = -0.5 \text{ mAdc}$)	^t on		25 60	ns
	c, $I_{C} = -50 \text{ mAdc}$, $I_{B1} = I_{B2} = -5.0 \text{ mAdc}$) c, $I_{C} = -10 \text{ mAdc}$, $I_{B1} = I_{B2} = -0.5 \text{ mAdc}$)	^t off		35 75	ns

1. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2.0%.



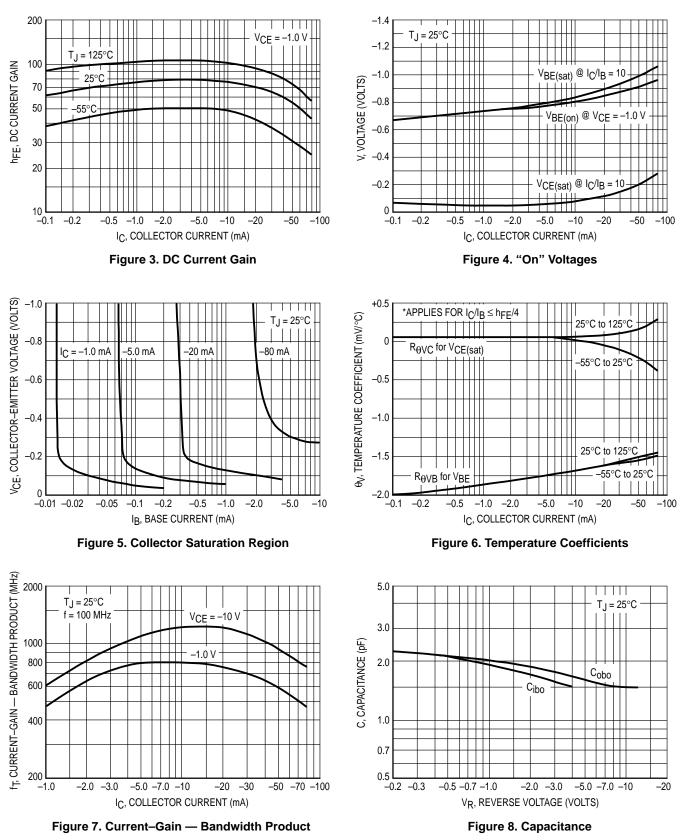




V_{BB} = -6.0 V

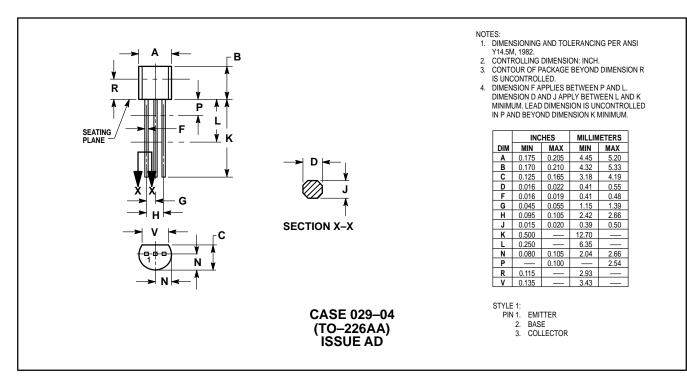
V_{CC} = 1.5 V





Motorola Small–Signal Transistors, FETs and Diodes Device Data

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